

Record No: 660 Control No: 3500

## RoHS and Lead Free Certificate of Compliance

| PART NUMBER | DESCRIPTION                 | ROHS Y      | Always Compliant: |  |
|-------------|-----------------------------|-------------|-------------------|--|
| WA-2300A    | 1 1/4 BLACK POINTER KNOB BR | LEAD FREE Y | Compliant Date:   |  |

This document certifies that the above stated GC Electronics product is compliant with the <u>Directive 2002/95/EC of the European Parliament on the Restriction of Hazardous Substances in electrical and electronics equipment (RoHS Directives)</u>. The stated product is deemed to be concentration values issued by the European Union Technical Adaptation Committee (TAC) as shown below.

|              | Maximum | Actual        |                                       | Maximum | Actual        |
|--------------|---------|---------------|---------------------------------------|---------|---------------|
| Substance    | Allowed | Concentration | Substance                             | Allowed | Concentration |
| LEAD - Pb    | 0.1%    | < 0.1%        | Hexavalent Chromium - Cr (VI)         | 0.1%    | < 0.1%        |
| Mercury - Hg | 0.1%    | < 0.1%        | Polybrominated - PBB                  | 0.1%    | < 0.1%        |
| Cadmium - Cd | 0.01%   | < 0.01%       | Polybrominated diphenyl ethers - PBDB | 0.1%    | < 0.1%        |

## RoHS exemptions.

Applications of lead, mercury, cadmium and hexavalent chromium, which are exempted from the requirements of Article 4(1) of the RoHS Directive

| requirements of Afficie 4(1) of the Roll's Directive. |   |  |
|---|---|--|
|   | Mercury in compact fluorescent lamps not exceeding 5 mg per lamp.   |  |
|   | Mercury in straight fluorescent lamps for general purposes not exceeding:  — halophosphate 10 mg  |  |
|   | — triphosphate with normal lifetime 5 mg  |  |
|   | — triphosphate with long lifetime 8 mg  |  |
|   | Mercury in straight fluorescent lamps for special purposes  |  |
|   | Mercury in other lamps not specifically mentioned in this Annex   |  |
|   | Lead in glass of cathode ray tubes, electronic components and fluorescent tubes   |  |
|   | Lead as an alloying element in steel containing up to 0,35 % lead by weight, aluminium containing up to 0,4 % lead by weight and as a copper alloy containing up to 4 % lead by weight  |  |
|   | <ul> <li>lead in high melting temperature type solders (i.e. lead-based alloys containing 85 % by weight or more lead)</li> <li>lead in solders for servers, storage and storage array systems, network infrastructure equipment for switching, signalling, transmission as well as network management for telecommunications</li> <li>lead in electronic ceramic parts (e.g. piezoelectronic devices)</li> </ul> |  |
|   | Cadmium and its compounds in electrical contacts and cadmium plating except for applications banned under Directive 91/38/EEC (1) amending Directive 76/769/EEC (2) relating to restrictions on the marketing and use of certain dangerous substances and preparations  |  |
|   | Hexavalent chromium as an anti-corrosion of the carbon steel cooling system in absorption refrigerators   |  |
| a   | DecaBDE in polymeric applications   |  |
| ь   | Lead in lead-bronze bearing shells and bushes   |  |
| 0   | Lead used in compliant pin connector systems  |  |
| <b>■</b> 1  | Lead as a coating material for the thermal conduction module c-ring   |  |
| 2   | Lead and cadmium in optical and filter glass  |  |
| 3   | Lead in solders consisting of more than two elements for the connection between the pins and the package of microprocessors with a lead content of more than 80% and less than 85% by weight  |  |
| 4   | Lead in solders to complete a viable electrical connection between semiconductor die and carrier within integrated circuit  |  |

Signed: Eric Smith - Product Manager GC Electronics